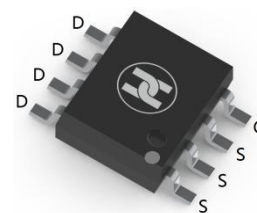
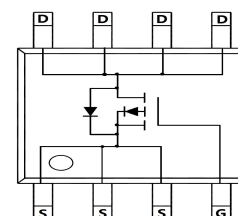


LOW VOLTAGE MOSFET (P-CHANNEL)
FEATURES

- Ultra low on-resistance: $V_{DS}=-30V, I_D=-10A, R_{DS(ON)} \leq 18m\Omega @ V_{GS}=-10V$
- Ultra low gate charge
- For load switch or in PWM applications
- Surface Mount device


SOP-8

MECHANICAL DATA

- Case: SOP-8
- Case Material: Molded Plastic. UL flammability
- Classification Rating: 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Weight: 0.3 grams (approximate)

MAXIMUM RATINGS ($T_A = 25^\circ C$ unless otherwise noted)

Parameter	Symbol	10Sec	Steady state	Unit	
Drain-source voltage	V_{DS}	-30		V	
Gate-source voltage	V_{GS}	± 25		V	
Continuous drain current	I_D	$T_A = 25^\circ C$	-10	-8	A
		$T_A = 70^\circ C$	-8	-6	A
Pulsed drain current	I_{DM}	-80		A	
Power dissipation	P_D	$T_A = 25^\circ C$	3.1	1.7	W
		$T_A = 70^\circ C$	2.0	1.1	W
Thermal resistance from Junction to ambient	$R_{\theta JA}$	75		$^\circ C/W$	
Thermal resistance from Junction to Lead	$R_{\theta JL}$	24		$^\circ C/W$	
Junction temperature	T_J	150		$^\circ C$	
Storage temperature	T_{STG}	-55 ~ +150		$^\circ C$	

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ C$ unless otherwise specified)

Parameter	Symbol	Min	Typ	Max	Unit	Conditions
Drain-Source breakdown voltage	$V_{(BR)DSS}^*$	-30			V	$V_{GS}=0V, I_D=-250\mu A$
Zero gate voltage drain current	I_{DSS}^*			-1	μA	$V_{DS}=-30V, V_{GS}=0V$
Gate-body leakage current	I_{GSS}^*			± 100	nA	$V_{DS}=0V, V_{GS}=\pm 25V$
Gate-threshold voltage	$V_{GS(th)}^*$	-1.7	-2.3	-3	V	$V_{DS}=V_{GS}, I_D=-250\mu A$
On-State Drain Current	$I_{D(ON)}^*$	-80			A	$V_{DS}=-5V, V_{GS}=-10V$
Drain-source on-resistance	$R_{DS(ON)}^*$		15	18	m Ω	$V_{GS}=-10V, I_D=-10A$
			22	27	m Ω	$V_{GS}=-10V, I_D=-10A, T_J=125^\circ C$
			27	36	m Ω	$V_{GS}=-5V, I_D=-5A$
Forward transconductance	g_{FS}		22		S	$V_{DS}=-5V, I_D=-10A$
Diode forward voltage	V_{SD}		-0.74	-1	V	$I_S=-1A, V_{GS}=0V$
Diode forward current	I_S			-3.5	A	
Input capacitance	C_{iss}		1130	1400	pF	$V_{DS}=-15V, V_{GS}=0V, f=1MHz$
Output capacitance	C_{oss}		240		pF	
Reverse transfer capacitance	C_{rss}		155		pF	
Gate resistance	R_g		5.8	8	Ω	$V_{DS}=0V, V_{GS}=0V, f=1MHz$
Total gate charge	Q_g		9.5		nC	$V_{GS}=-4.5V, V_{DS}=-15V, I_D=-10A$
Total gate charge			18	24	nC	
Gate-source charge	Q_{gs}		5.5		nC	$V_{GS}=-10V, V_{DS}=-15V, I_D=-10A$
Gate-drain charge	Q_{gd}		3.3		nC	
Turn-on delay time	$t_{d(on)}$		8.7		nS	$V_{GS}=-10V, V_{DS}=-15V, R_{GEN}=3\Omega, R_L=1.67\Omega$
Turn-on rise time	t_r		8.5		nS	
Turn-off delay time	$t_{d(off)}$		18		nS	
Turn-off fall time	t_f		7		nS	
Body Diode Reverse Recovery Time	t_{rr}		25	30	nS	$I_F=-10A, di/dt=100A/\mu s$
Body Diode Reverse Recovery Charge	Q_{rr}		12		nC	$I_F=-10A, di/dt=100A/\mu s$

*Pulse test ; Pulse width $\leq 300\mu s$, Duty cycle $\leq 0.5\%$.

LOW VOLTAGE MOSFET (P-CHANNEL)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

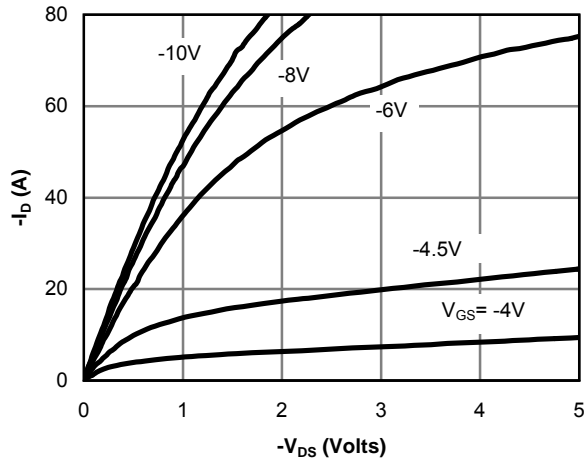


Figure 1: On-Region Characteristics

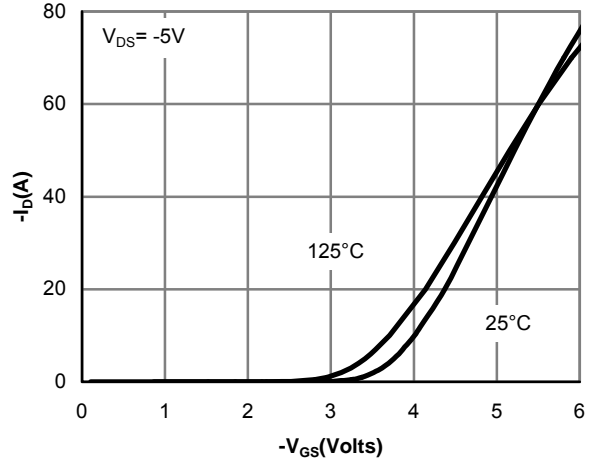


Figure 2: Transfer Characteristics

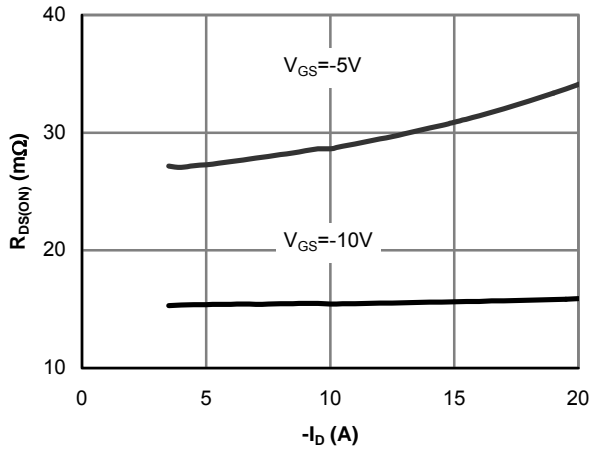


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

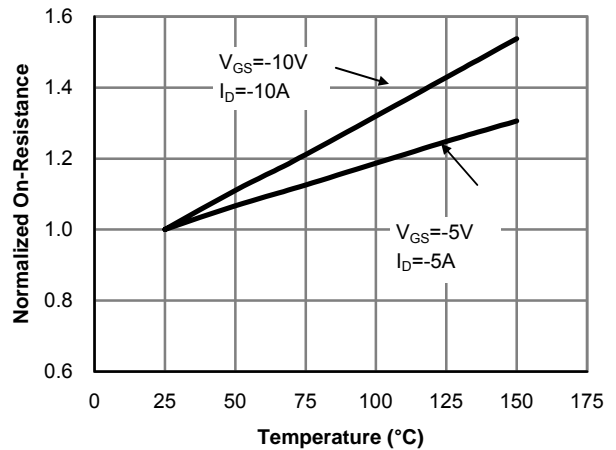


Figure 4: On-Resistance vs. Junction Temperature

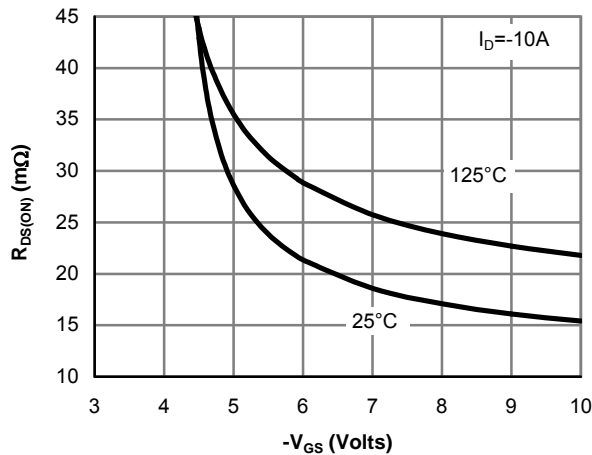


Figure 5: On-Resistance vs. Gate-Source Voltage

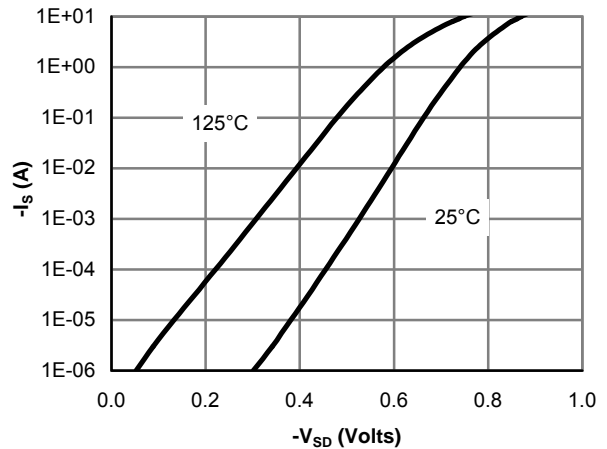


Figure 6: Body-Diode Characteristics

LOW VOLTAGE MOSFET (P-CHANNEL)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

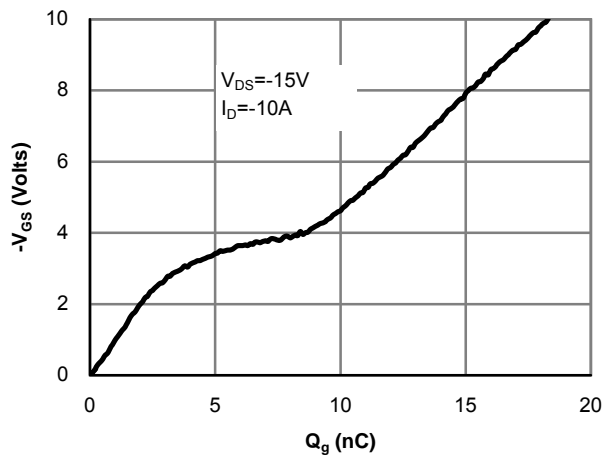


Figure 7: Gate-Charge Characteristics

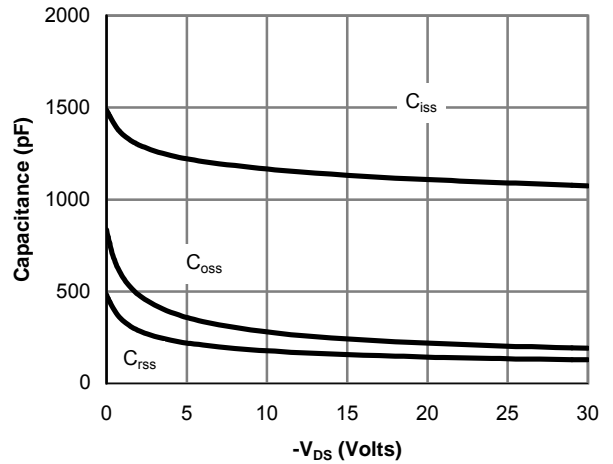


Figure 8: Capacitance Characteristics

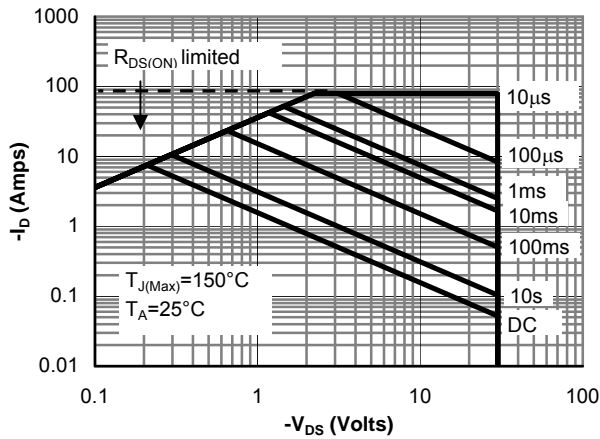


Figure 9: Maximum Forward Biased Safe Operating Area

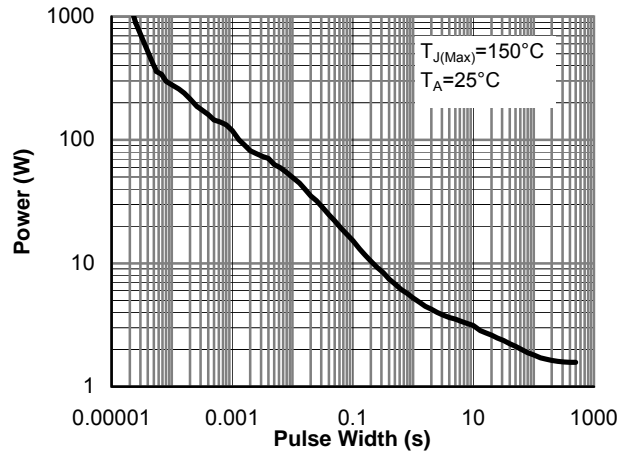


Figure 10: Single Pulse Power Rating Junction-to-Ambient

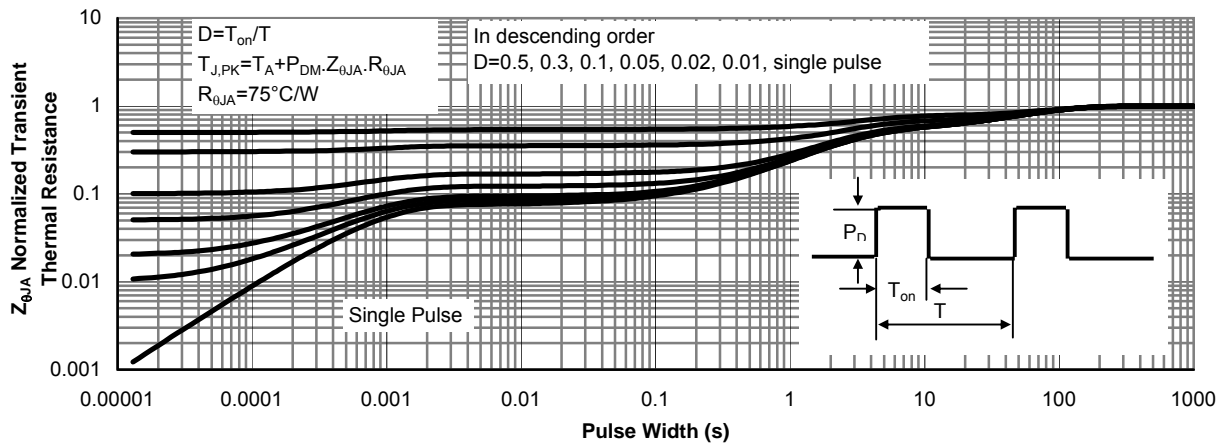
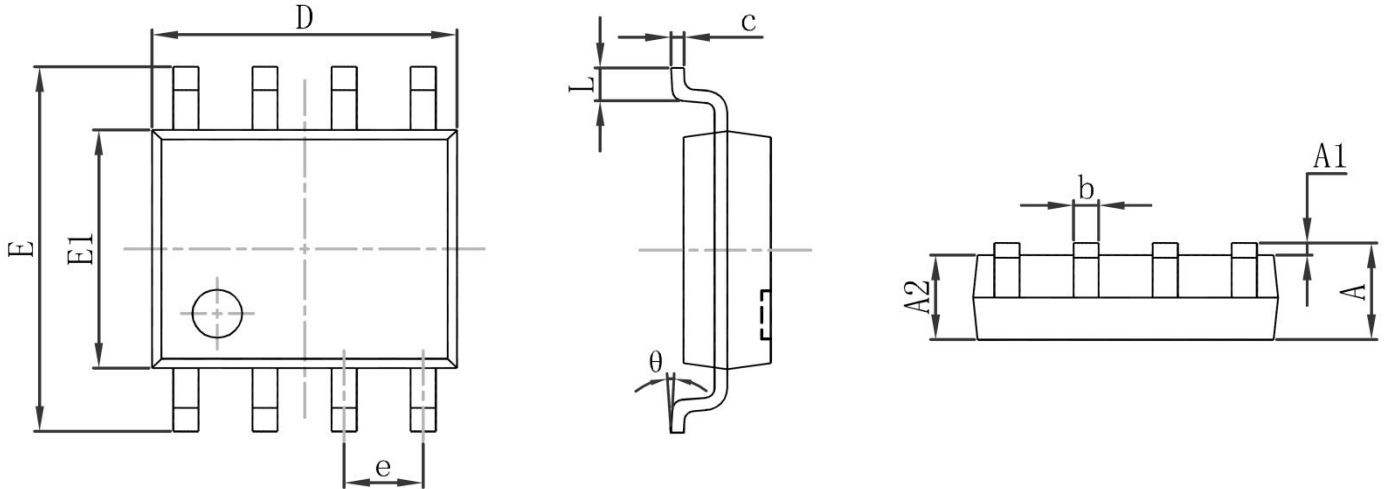


Figure 11: Normalized Maximum Transient Thermal Impedance

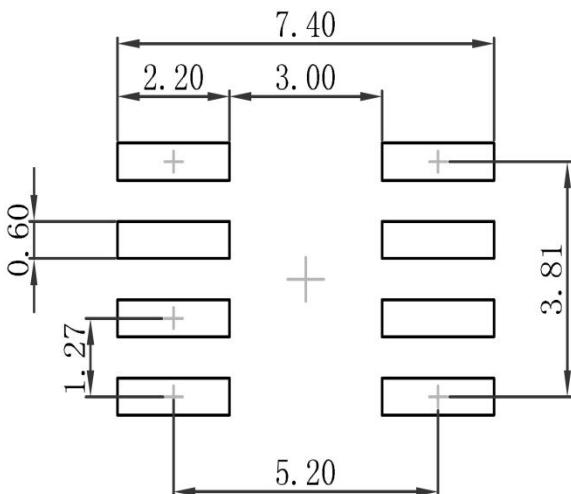
LOW VOLTAGE MOSFET (P-CHANNEL)

SOP-8 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.007	0.010
D	4.800	5.000	0.189	0.197
e	1.270(BSC)		0.050 (BSC)	
E	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

SOP-8 Suggested Pad Layout



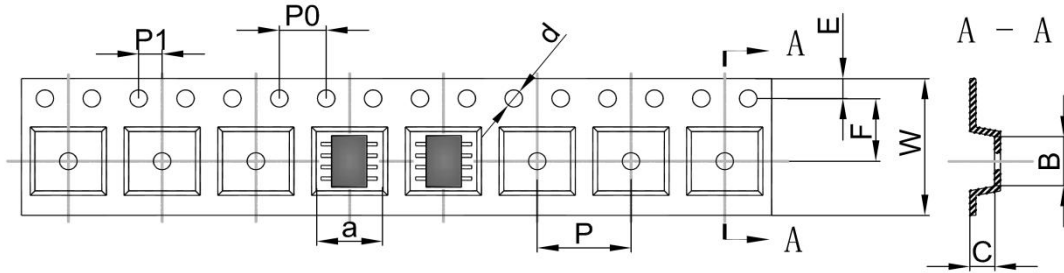
Note:

1. Controlling dimension: in millimeters
2. General tolerance: ±0.05mm
3. The pad layout is for reference purposes only

LOW VOLTAGE MOSFET (P-CHANNEL)

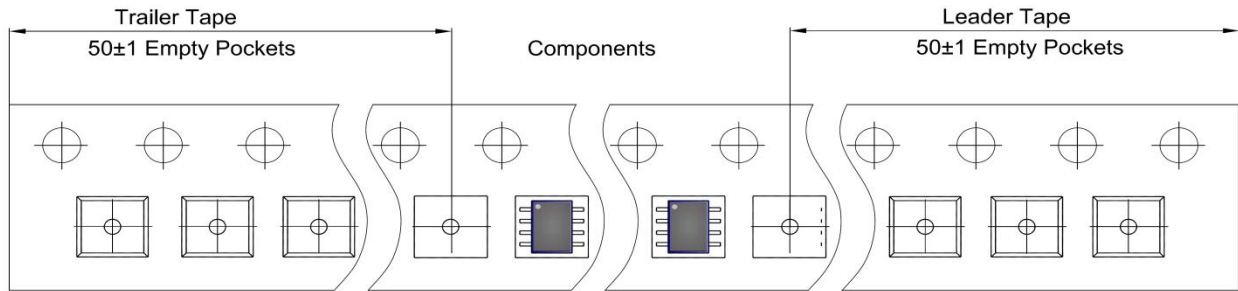
SOP-8 Tape and Reel

SOP-8 Embossed Carrier Tape

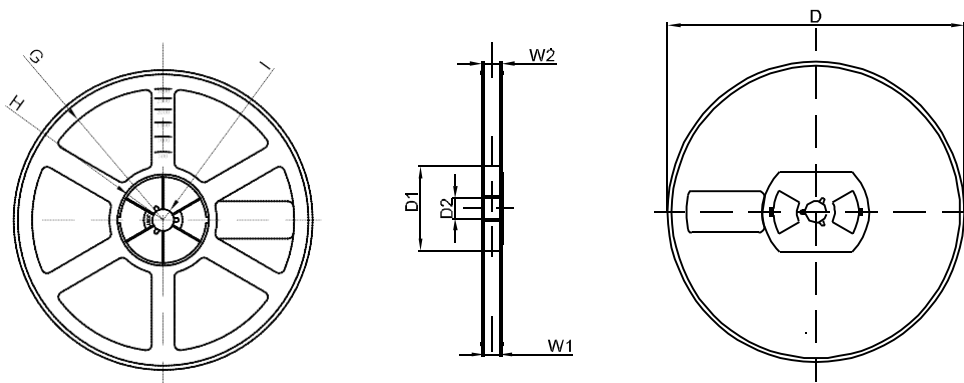


DIMENSIONS ARE IN MILLIMETER										
TYPE	A	B	C	d	E	F	P0	P	P1	W
SOP-8	6.40	5.40	2.10	Ø1.50	1.75	5.50	4.00	8.00	2.00	12.00
TOLERANCE	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1

SOP-8 Tape Leader and Trailer



SOP-8 Reel



DIMENSIONS ARE IN MILLIMETER								
REEL OPTION	D	D1	D2	G	H	I	W1	W2
13" DIA	Ø330.00	100.00	13.00	R151.00	R56.00	R6.50	12.40	17.60
TOLERANCE	±2	±1	±1	±1	±1	±1	±1	±1